



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C		
60V	$50m\Omega$ @ $V_{GS} = 10V$	25A		
	$65m\Omega @ V_{GS} = 4.5V$	22A		

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported up by a PPAP and is ideal for use in:

- Driving Solenoids
- Driving Relays
- Power Management Functions

Features

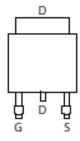
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low On-Resistance
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

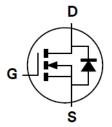
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Weight: 0.315 grams (Approximate)







Pin Out Top View



Equivalent Circuit

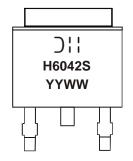
Ordering Information (Note 5)

Part Number	Case	Packaging
DMNH6042SK3Q-13	TO252 (DPAK)	2,500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



J!! = Manufacturer's Marking
 H6042S = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 16 = 2016)
 WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 8) $V_{GS} = 10V$ Steady $T_C = +25^{\circ}C$ State $T_C = +70^{\circ}C$			I _D	25 17	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	40	Α
Maximum Continuous Body Diode Forward Current (Note 8)			Is	25	Α
Avalanche Current (Note 9) L = 10mH			I _{AS}	3.5	Α
Avalanche Energy (Note 9) L = 10mH			E _{AS}	65	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 6)		P_{D}	2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	73	°C/W
Internal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	36	
Total Power Dissipation (Note 7)		P_{D}	3.5	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	43	°C/W
Themai Resistance, Junction to Ambient (Note 7)	t<10s	$R_{\theta JA}$	21	
Thermal Resistance, Junction to Case (Note 8)	$R_{ heta JC}$	3.2		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 10)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 10)							
Gate Threshold Voltage	$V_{GS(TH)}$	1.0		3.0	٧	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance			30	50	mΩ	$V_{GS} = 10V, I_D = 6A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	45	65	11122	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_S = 2.6A$	
DYNAMIC CHARACTERISTICS (Note 11)							
Input Capacitance	C _{iss}	1	584	_	рF	.,	
Output Capacitance	Coss		83	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	24	_	pF	1 = 1.0101112	
Gate Resistance	R_g	_	3.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		4.2	_	nC		
Total Gate Charge (V _{GS} = 10V)	Q_g	_	8.8	_	nC	1,, 40,, 500	
Gate-Source Charge	Q _{gs}	_	1.8	_	nC	$V_{DS} = 44V, I_D = 5.2A$	
Gate-Drain Charge	Q_{gd}	_	1.8	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	3.4	_	ns		
Turn-On Rise Time	t _R	_	1.9	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_G = 6\Omega, I_D = 1A$	
Turn-Off Delay Time	t _{D(OFF)}	_	10.1	_	ns		
Turn-Off Fall Time	t _F	_	4.5	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	_	12.9	_	ns	-I _F = 2.6A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	5.4	_	nC		

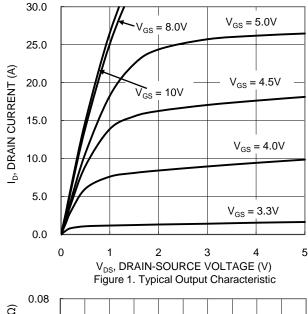
Notes:

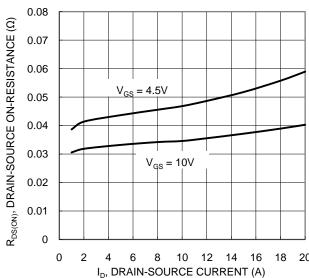
- 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 8. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 9. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 10. Short duration pulse test used to minimize self-heating effect.

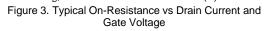
 11. Guaranteed by design. Not subject to product testing.











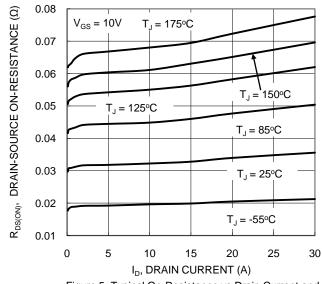
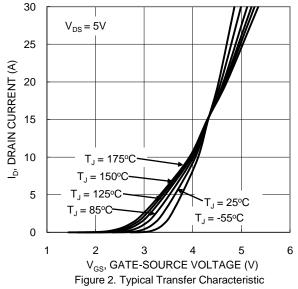


Figure 5. Typical On-Resistance vs Drain Current and Temperature



0.1 $R_{DS(ON)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.09 = 5.1A0.08 0.07 0.06 0.05 0.04 0.03 $I_{D} = 4.4A$ 0.02 0.01 2 10 12 14 16 18 V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 4. Typical Transfer Characteristic

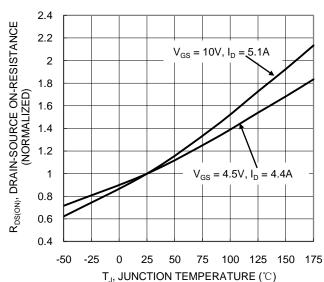


Figure 6. On-Resistance Variation with Temperature





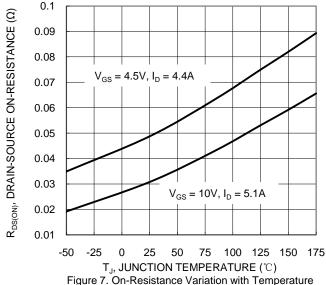


Figure 7. On-Resistance Variation with Temperature

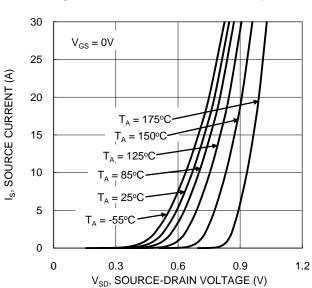


Figure 9. Diode Forward Voltage vs. Current

10 8 6 $V_{GS}(V)$ 4 $V_{DS} = 44V, I_{D} = 5.2A$ 2 0 0 2 8 10

 Q_a (nC)

Figure 11. Gate Charge

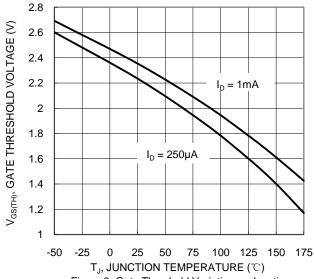
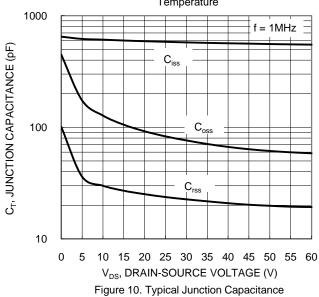
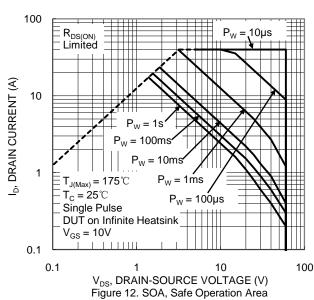


Figure 8. Gate Threshold Variation vs Junction Temperature







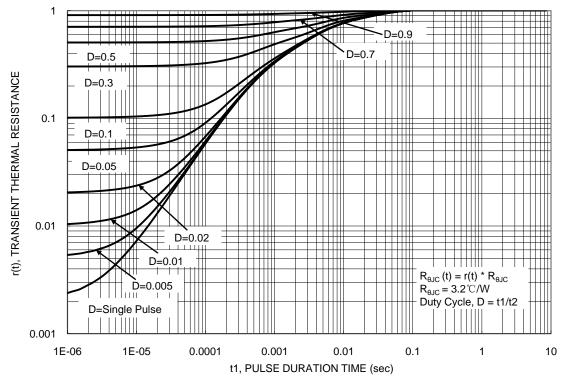


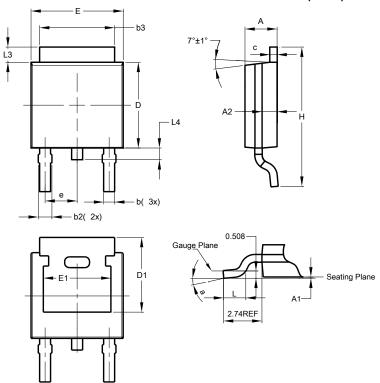
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

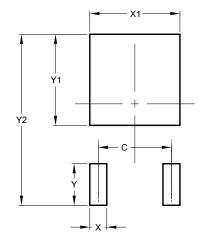


TO252 (DPAK)						
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A 1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Е	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
٦	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
Y2	10 700		



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